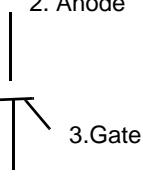
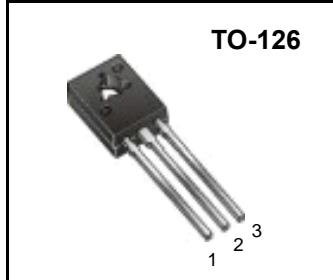


Sensitive Gate Silicon Controlled - Rectifiers

Features

Repetitive Peak Off-State Voltage : 600V
 R.M.S On-State Current ($I_{T(RMS)} = 2.0 \text{ A}$)
 On-State Voltage (2.2V(max) @ $I_{TM} = 4\text{A}$)
 Pb - Free Packages are Available

Symbol 	$BV_{DRM} = 600\text{V}$ $I_{T(RMS)} = 2.0 \text{ A}$ $I_{TSM} = 4 \text{ A}$
	TO-126

General Description

Sensitive-gate triggering thyristor is suitable for the application where requiring low gate triggering current system
 Used for electric blanket ,electronic jar ,temperature control, lighting control such as a entertainment display.
 Automatic ignition system , Battery charger .

Absolute Maximum Ratings ($T_J = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Condition	Ratings	Units
V_{DRM}	Repetitive Peak Off-State Voltage	sine wave,50 to 60Hz,gate open	600	V
$I_{T(AV)}$	Average On-State Current	half sine wave : $T_C = 77^\circ\text{C}$	2.0	A
$I_{T(RMS)}$	R.M.S On-State Current	180° Conduction Angle	4	A
I_{TSM}	Surge On-State Current	1/2 Cycle, 60Hz, Sine Wave Non-Repetitive	20	A
I^2t	I^2t for Fusing	$t = 8.3\text{ms}$	1.65	A^2s
P_{GM}	Forward Peak Gate Power Dissipation	$T_C = 77^\circ\text{C}$, pulse width $1.0\mu\text{s}$	0.5	W
$P_{G(AV)}$	Forward Average Gate Power Dissipation	$T_C = 77^\circ\text{C}$,pulse width $1.0\mu\text{s}$	0.1	W
I_{FGM}	Forward Peak Gate Current	$T_C = 77^\circ\text{C}$, pulse width $1.0\mu\text{s}$	0.2	A
V_{RGM}	Reverse Peak Gate Voltage	$T_C = 77^\circ\text{C}$, pulse width $1.0\mu\text{s}$	5.0	V
T_J	Operating Junction Temperature		- 40 ~ 125	$^\circ\text{C}$
T_{STG}	Storage Temperature		- 40 ~ 125	$^\circ\text{C}$

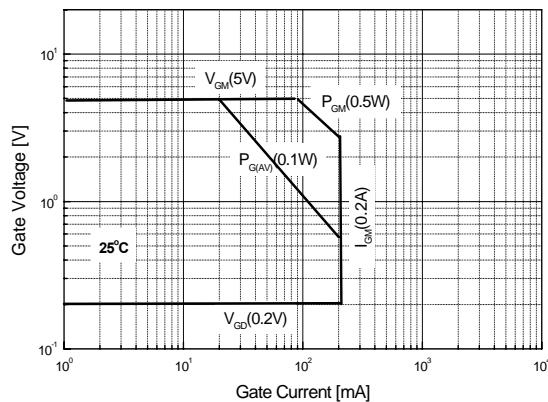
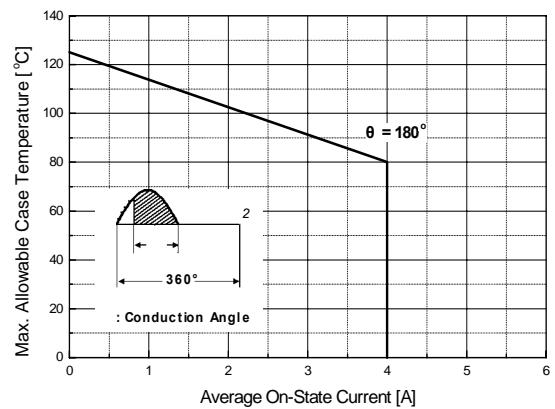
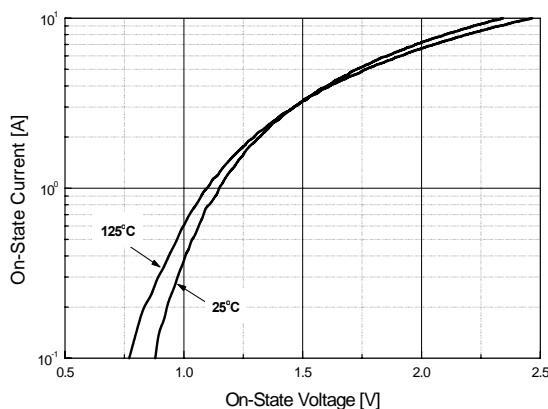
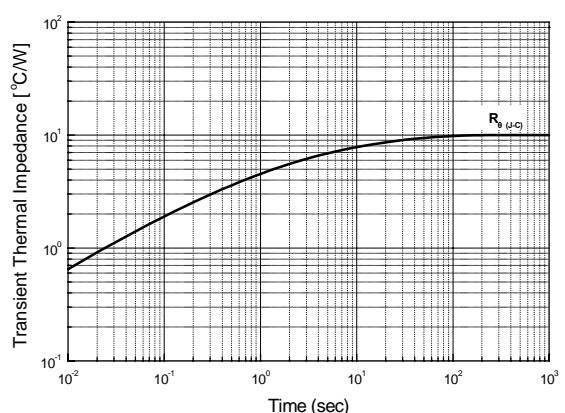
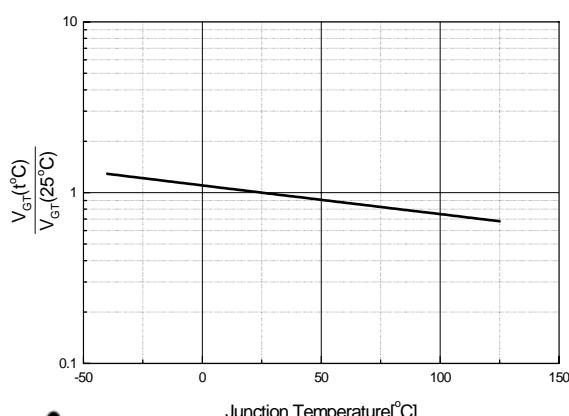
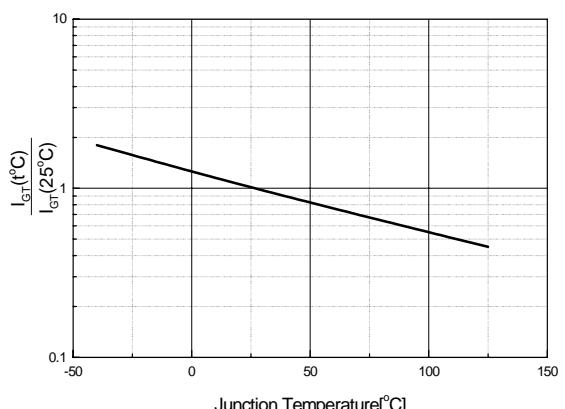
D2P6M

Electrical Characteristics ($T_C = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Items	Conditions	Ratings			Unit
			Min.	Typ.	Max.	
I_{DRM}	Repetitive Peak Off-State Current	$V_{AK} = V_{DRM}$ $T_C = 25^\circ\text{C}$ $T_C = 125^\circ\text{C}$			10 200	μA
V_{TM}	Peak On-State Voltage (1)	$I_{TM} = 4 \text{ A}$ $t_p = 380\mu\text{s}$			2.2	V
I_{GT}	Gate Trigger Current (2)	$V_{AK} = 6 \text{ V(DC)}$, $R_L=10$ $T_C = 25^\circ\text{C}$			200	μA
V_{GT}	Gate Trigger Voltage (2)	$V_D = 6 \text{ V(DC)}$, $R_L=10$ $T_C = 25^\circ\text{C}$			1.5	V
V_{GD}	Non-Trigger Gate Voltage (1)	$V_{AK} = 12 \text{ V}$, $R_L=100$ $T_C = 125^\circ\text{C}$	0.2			V
dv/dt	Critical Rate of Rise Off-State Voltage	Linear slope up to $V_D = V_{DRM} 67\%$ $R_{GK} = 1 \text{ Kohm}$ $T_J = 125^\circ\text{C}$	10			V/ μs
I_H	Holdling Current	$I_T = 20\text{mA}$, Gate Open $T_C = 25^\circ\text{C}$			3	mA
$R_{th(j-c)}$	Thermal Impedance	Junction to case			10	$^\circ\text{C/W}$
$R_{th(j-a)}$	Thermal Impedance	Junction to Ambient			75	$^\circ\text{C/W}$

Notes :

1. Pulse Width = 1.0 ms , Duty cycle 1%
2. R_{GK} Current not Included in measurement

D2P6M**Fig 1. Gate Characteristics****Fig 2. Maximum Case Temperature****Fig 3. Typical Forward Voltage****Fig 4. Thermal Response****Fig 5. Typical Gate Trigger Voltage vs.****Fig 6. Typical Gate Trigger Current vs. Junction Temperature**

D2P6M

Fig 7. Typical Holding Current

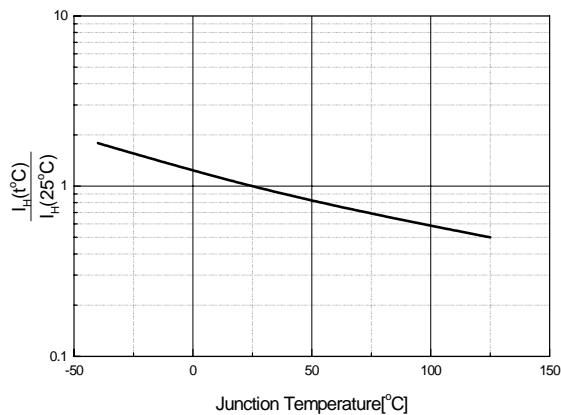
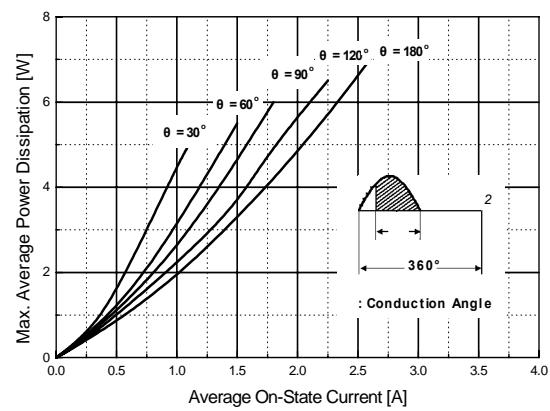


Fig 8. Power Dissipation



D2P6M**TO-126 Package Dimension**

Dim.	mm			Inch		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	7.5		7.9	0.295		0.311
B	10.8		11.2	0.425		0.441
C	14.2		14.7	0.559		0.579
D	2.7		2.9	0.106		0.114
E		3.8			0.150	
F		2.5			0.098	
G	1.2		1.5	0.047		0.059
H		2.3			0.091	
I		4.6			0.181	
J	0.48		0.62	0.019		0.024
K	0.7		0.86	0.028		0.034
L		1.4			0.055	
		3.2			0.126	

